

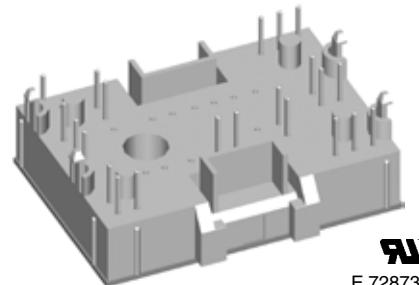
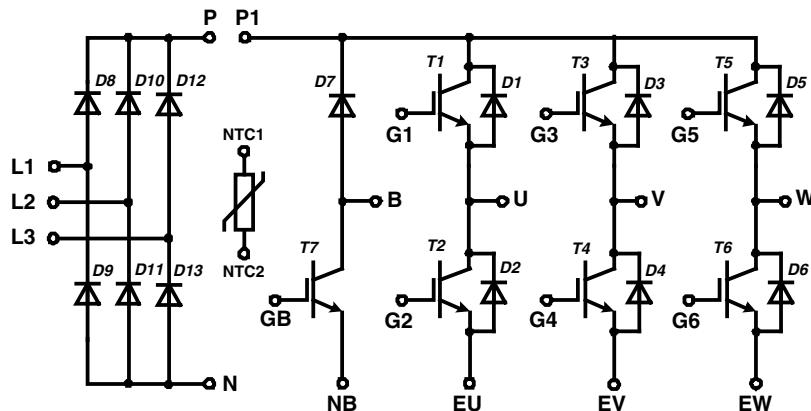
# Converter - Brake - Inverter Module

## Trench IGBT

Single Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 600 \text{ V}$	$V_{CES} = 600 \text{ V}$
$I_{DAVM25} = 90 \text{ A}$	$I_{C25} = 29 \text{ A}$	$I_{C25} = 29 \text{ A}$
$I_{FSM} = 270 \text{ A}$	$V_{CE(sat)} = 2.1 \text{ V}$	$V_{CE(sat)} = 2.1 \text{ V}$

**Part name** (Marking on product)

MITA30WB600TMH



Pin configuration see outlines.

### Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with Trench IGBTs
  - low saturation voltage
  - positive temperature coefficient
  - fast switching
  - short tail current
- Epitaxial free wheeling diodes with hiperfast soft reverse recovery
- Temperature sense included

### Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

### Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
  - IXKU 5-505 screw clamp
  - IXRB 5-506 click clamp
- UL registered E72873

## Output Inverter T1 - T6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage	$T_{VJ} = 150^\circ\text{C}$			600	V	
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V	
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$			40	A	
$I_{C80}$		$T_C = 80^\circ\text{C}$			27	A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$			90	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 30 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	1.5	1.8	V	
			$T_{VJ} = 125^\circ\text{C}$	1.7	1.9	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.45 \text{ A}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5		6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	1.8	2.25	mA	
			$T_{VJ} = 125^\circ\text{C}$	2	5	mA	
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			300	nA	
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$			1630	pF	
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 10 \text{ A}$			300	nC	
$t_{d(on)}$	turn-on delay time	<div style="border: 1px solid black; padding: 5px; display: inline-block;">inductive load <math>V_{CE} = 600 \text{ V}; I_C = 30 \text{ A}</math> <math>V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega</math></div>	$T_{VJ} = 25^\circ\text{C}$	tbd		ns	
$t_r$	current rise time			tbd		ns	
$t_{d(off)}$	turn-off delay time			tbd		ns	
$t_f$	current fall time			tbd		ns	
$E_{on}$	turn-on energy per pulse			tbd		mJ	
$E_{off}$	turn-off energy per pulse			tbd		mJ	
$t_{d(on)}$	turn-on delay time	<div style="border: 1px solid black; padding: 5px; display: inline-block;">inductive load <math>V_{CE} = 600 \text{ V}; I_C = 30 \text{ A}</math> <math>V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega</math></div>	$T_{VJ} = 125^\circ\text{C}$	20		ns	
$t_r$	current rise time			20		ns	
$t_{d(off)}$	turn-off delay time			160		ns	
$t_f$	current fall time			60		ns	
$E_{on}$	turn-on energy per pulse			0.65		mJ	
$E_{off}$	turn-off energy per pulse			0.75		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega; I_C = 60 \text{ A}$	$T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot L_S \cdot d_I/dt$		V	
<b>t<sub>sc</sub> (SCSOA)</b>	short circuit safe operating area	$V_{CE} = 360 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega; t_p = 10 \mu\text{s}$	$T_{VJ} = 125^\circ\text{C}$	10		μs	
$R_{thJC}$	thermal resistance junction to case	(per IGBT)	$T_{VJ} = 125^\circ\text{C}$		1.4	K/W	
$R_{thCH}$	thermal resistance case to heatsink				0.5	K/W	

## Output Inverter D1 - D6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			600	V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$			69	A
$I_{F80}$		$T_C = 80^\circ\text{C}$			46	A
$V_F$	forward voltage	$I_F = 30 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	1.2	1.7	V
			$T_{VJ} = 125^\circ\text{C}$		1.4	V
$Q_{rr}$	reverse recovery charge	<div style="border: 1px solid black; padding: 5px; display: inline-block;"><math>V_R = \text{tbd} \text{ V}</math> <math>di_F/dt = \text{tbd} \text{ A}/\mu\text{s}</math> <math>I_F = \text{tbd} \text{ A}; V_{GE} = 0 \text{ V}</math></div>	$T_{VJ} = 125^\circ\text{C}$	tbd		μC
$I_{RM}$	max. reverse recovery current			tbd		A
$t_{rr}$	reverse recovery time			tbd		ns
$E_{rec}$	reverse recovery energy			tbd		μJ
$R_{thJC}$	thermal resistance junction to case	(per diode)	$T_C = 25^\circ\text{C}$ unless otherwise stated		0.9	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.3	K/W

IXYS reserves the right to change limits, test conditions and dimensions.

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## Brake T7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit	
$V_{CES}$	collector emitter voltage	$T_{VJ} = 150^\circ\text{C}$			600	V	
$V_{GES}$	max. DC gate voltage	continuous			$\pm 20$	V	
$V_{GEM}$	max. transient collector gate voltage	transient			$\pm 30$	V	
$I_{C25}$	collector current	$T_C = 25^\circ\text{C}$			40	A	
$I_{C80}$		$T_C = 80^\circ\text{C}$			27	A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ\text{C}$			90	W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 30 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	1.5	1.8	V	
			$T_{VJ} = 125^\circ\text{C}$	1.7	1.9	V	
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.45 \text{ A}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5		6.5	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$		2	mA	
			$T_{VJ} = 125^\circ\text{C}$		1	4	mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			300	nA	
$C_{ies}$	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		1630		pF	
$Q_{G(on)}$	total gate charge	$V_{CE} = 300 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 10 \text{ A}$		300		nC	
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 25^\circ\text{C}$ inductive load $V_{CE} = 600 \text{ V}; I_C = 30 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega$			tbd	ns	
$t_r$	current rise time				tbd	ns	
$t_{d(off)}$	turn-off delay time				tbd	ns	
$t_f$	current fall time				tbd	ns	
$E_{on}$	turn-on energy per pulse				tbd	mJ	
$E_{off}$	turn-off energy per pulse				tbd	mJ	
$t_{d(on)}$	turn-on delay time	$T_{VJ} = 125^\circ\text{C}$ inductive load $V_{CE} = 600 \text{ V}; I_C = 30 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega$		20		ns	
$t_r$	current rise time			20		ns	
$t_{d(off)}$	turn-off delay time			160		ns	
$t_f$	current fall time			60		ns	
$E_{on}$	turn-on energy per pulse			0.65		mJ	
$E_{off}$	turn-off energy per pulse			0.75		mJ	
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega; I_C = 60 \text{ A}$	$T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot L_S \cdot d_I / dt$		V	
<b>t<sub>sc</sub> (SCSOA)</b>	short circuit safe operating area	$V_{CE} = 360 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 15 \Omega; t_p = 10 \mu\text{s}$	$T_{VJ} = 125^\circ\text{C}$	10		A	
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			1.4	K/W	
$R_{thCH}$	thermal resistance case to heatsink			0.45		K/W	

## Brake Chopper D7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 150^\circ\text{C}$			600	V
$I_{F25}$	forward current	$T_C = 25^\circ\text{C}$			22	A
$I_{F80}$		$T_C = 80^\circ\text{C}$			14	A
$V_F$	forward voltage	$I_F = 30 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	1.65	2.47	V
			$T_{VJ} = 125^\circ\text{C}$	1.60	1.99	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$	50	60	$\mu\text{A}$
			$T_{VJ} = 125^\circ\text{C}$	0.2	0.25	mA
$Q_{rr}$	reverse recovery charge	$T_{VJ} = 125^\circ\text{C}$ $V_R = 300 \text{ V}$ $dI_F/dt = -400 \text{ A}/\mu\text{s}$ $I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$			tbd	$\mu\text{C}$
$I_{RM}$	max. reverse recovery current				11	A
$t_{rr}$	reverse recovery time				80	ns
$E_{rec}$	reverse recovery energy				tbd	$\mu\text{J}$
$R_{thJC}$	thermal resistance junction to case	(per diode)			2.5	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.85		K/W

 $T_C = 25^\circ\text{C}$  unless otherwise stated

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**Input Rectifier Bridge D8 - D11****Ratings**

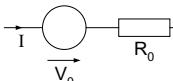
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
<b>V<sub>RRM</sub></b>	max. repetitive reverse voltage		T <sub>VJ</sub> = 25°C		1600	V
<b>I<sub>FAV</sub></b>	average forward current	sine 180°	T <sub>C</sub> = 80°C		31	A
<b>I<sub>DAVM</sub></b>	max. average DC output current	rect.; d = 1/3	T <sub>C</sub> = 80°C		89	A
<b>I<sub>FSM</sub></b>	max. forward surge current	t = 10 ms; sine 50 Hz	T <sub>VJ</sub> = 25°C T <sub>VJ</sub> = 125°C		320 280	A A
<b>I<sup>2</sup>t</b>	I <sup>2</sup> t value for fusing	t = 10 ms; sine 50 Hz	T <sub>VJ</sub> = 25°C T <sub>VJ</sub> = 125°C		510 390	A <sup>2</sup> s A <sup>2</sup> s
<b>P<sub>tot</sub></b>	total power dissipation		T <sub>C</sub> = 25°C		80	W
<b>V<sub>F</sub></b>	forward voltage	I <sub>F</sub> = 30 A	T <sub>VJ</sub> = 25°C T <sub>VJ</sub> = 125°C	1.2 1.1	1.50 1.21	V V
<b>I<sub>R</sub></b>	reverse current	V <sub>R</sub> = V <sub>RRM</sub>	T <sub>VJ</sub> = 25°C T <sub>VJ</sub> = 125°C	20 1.5		μA mA
<b>R<sub>thJC</sub></b>	thermal resistance junction to case	(per diode)			1.4	K/W
<b>R<sub>thCH</sub></b>	thermal resistance case to heatsink	(per diode)			0.45	K/W

**Temperature Sensor NTC****Ratings**

<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
<b>R<sub>25</sub></b>	resistance		T <sub>C</sub> = 25°C	4.75	5.0 3375	kΩ K

**Module****Ratings**

<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
<b>T<sub>VJ</sub></b>	operating temperature		-40		125	°C
<b>T<sub>VJM</sub></b>	max. virtual junction temperature				150	°C
<b>T<sub>stg</sub></b>	storage temperature		-40		125	°C
<b>V<sub>ISOL</sub></b>	isolation voltage	I <sub>ISOL</sub> ≤ 1 mA; 50/60 Hz			2500	V~
<b>CTI</b>	comparative tracking index			-		
<b>F<sub>c</sub></b>	mounting force		40		80	N
<b>d<sub>s</sub></b>	creep distance on surface		12.7			mm
<b>d<sub>A</sub></b>	strike distance through air		12			mm
<b>Weight</b>				35		g

**Equivalent Circuits for Simulation****Ratings**

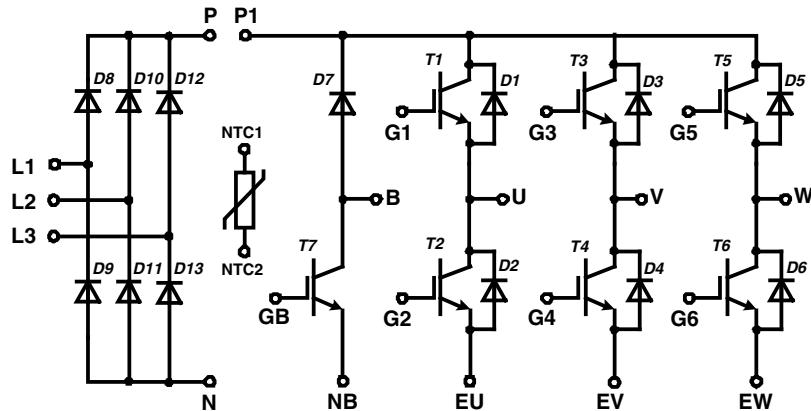
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
<b>V<sub>0</sub></b>	rectifier diode	D8 - D13	T <sub>VJ</sub> = 125°C	0.9 9		V mΩ
<b>R<sub>0</sub></b>						
<b>V<sub>0</sub></b>	IGBT	T1 - T6	T <sub>VJ</sub> = 125°C	0.9 20		V mΩ
<b>R<sub>0</sub></b>						
<b>V<sub>0</sub></b>	free wheeling diode	D1 - D6	T <sub>VJ</sub> = 125°C	1.05 7		V mΩ
<b>R<sub>0</sub></b>						
<b>V<sub>0</sub></b>	IGBT	T7	T <sub>VJ</sub> = 125°C	0.9 20		V mΩ
<b>R<sub>0</sub></b>						
<b>V<sub>0</sub></b>	free wheeling diode	D7	T <sub>VJ</sub> = 125°C	1.25 25		V mΩ

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T<sub>C</sub> = 25°C unless otherwise stated

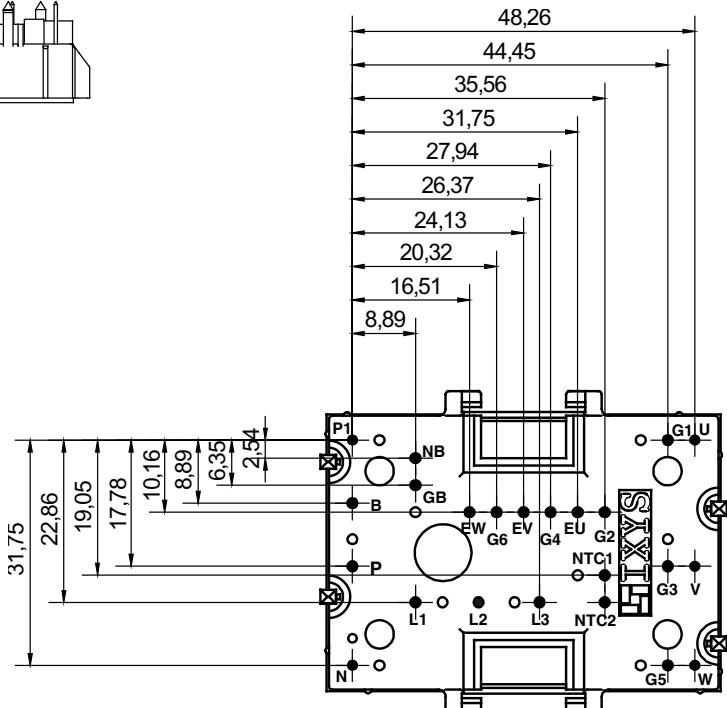
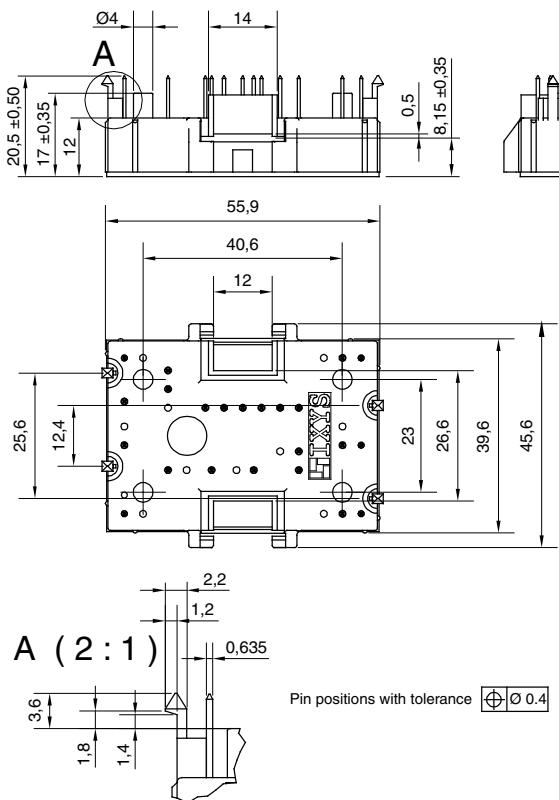
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## Circuit Diagram

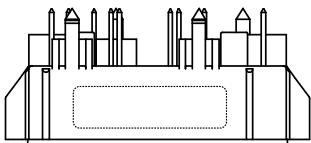


## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking



## Part number

M = Module  
 I = IGBT  
 T = Standard trench  
 A = Gen 1 / std  
 30 = Current Rating [A]  
 WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit  
 600 = Reverse Voltage [V]  
 T = NTC  
 MH = MiniPack2

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MITA 30 WB 600 TMH	MITA30WB600TMH	Box	20	505721